

To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Phase-out/Discontinued

1.8 V, OPERATION POWER AMPLIFIER FOR Bluetooth™ Class 1

DESCRIPTION

The μPG2251T6M is a GaAs MMIC for power amplifier which was developed for Bluetooth Class 1.

This device realizes high efficiency, high gain and high output power.

This device is housed in a 12-pin plastic TSQFN (Thin Small Quad Flat Non-leaded) (T6M) package. And this package is able to high-density surface mounting.

FEATURES

- Operating frequency : $f_{opt} = 2\ 400$ to $2\ 500$ MHz (2 450 MHz TYP.)
- Supply voltage : $V_{DD1, 2, 3} = 2.5$ to 3.5 V (3.0 V TYP.)
- Control voltage : $V_{cont} = 1.5$ to 2.1 V (1.8 V TYP.)
- Circuit current : $I_{DD} = 230$ mA TYP. @ $V_{DD1, 2, 3} = 3.0$ V, $V_{cont} = 1.8$ V, $P_{out} = +25$ dBm
- Output power : $P_{out} = +25.0$ dBm TYP. @ $V_{DD1, 2, 3} = 3.0$ V, $V_{cont} = 1.8$ V, $P_{in} = -5$ dBm
- Gain control range : GCR = 70 dB TYP. @ $V_{DD1, 2, 3} = 3.0$ V, $V_{cont} = 0$ to 1.8 V, $P_{in} = -5$ dBm
- High efficiency : PAE = 47% TYP. @ $V_{DD1, 2, 3} = 3.0$ V, $V_{cont} = 1.8$ V, $P_{in} = -5$ dBm
- High-density surface mounting : 12-pin plastic TSQFN (T6M) package ($2.0 \times 2.0 \times 0.37$ mm)

APPLICATION

- Power Amplifier for Bluetooth Class 1, ZigBee™ etc.

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2251T6M-E2	μPG2251T6M-E2-A	12-pin plastic TSQFN (T6M) (Pb-Free)	2251	<ul style="list-style-type: none"> • Embossed tape 8 mm wide • Pin 10, 11, 12 face the perforation side of the tape • Qty 3 kpcs/reel

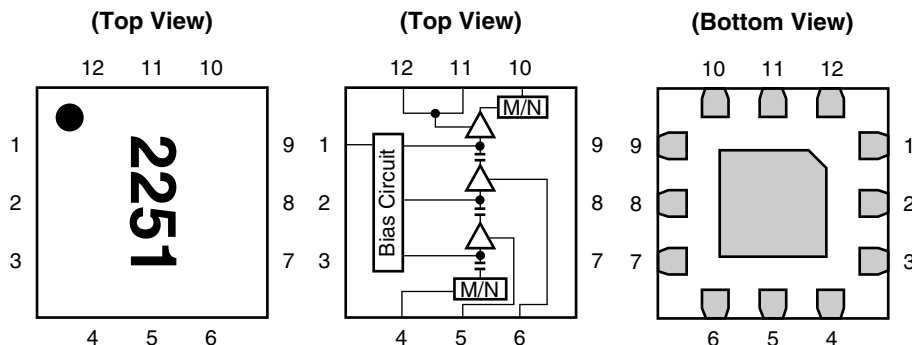
Remark To order evaluation samples, please contact your nearby sales office.

Part number for sample order: μPG2251T6M

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	V _{cont}
2	GND
3	GND
4	P _{in}
5	V _{DD1}
6	V _{DD2}
7	GND
8	GND
9	GND
10	P _{out}
11	V _{DD3}
12	V _{DD3}

Remark Exposed pad : GND

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V _{DD1, 2, 3}	6.0	V
Control Voltage	V _{cont}	3.0	V
Circuit Current	I _{DD}	300	mA
Control Current	I _{cont}	0.5	mA
Input Power	P _{in}	+10	dBm
Power Dissipation	P _D	600 ^{Note}	mW
Operating Ambient Temperature	T _A	-40 to +85	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Note Mounted on double-sided copper-clad 50 × 50 × 1.6 mm epoxy glass PWB, T_A = +85°C

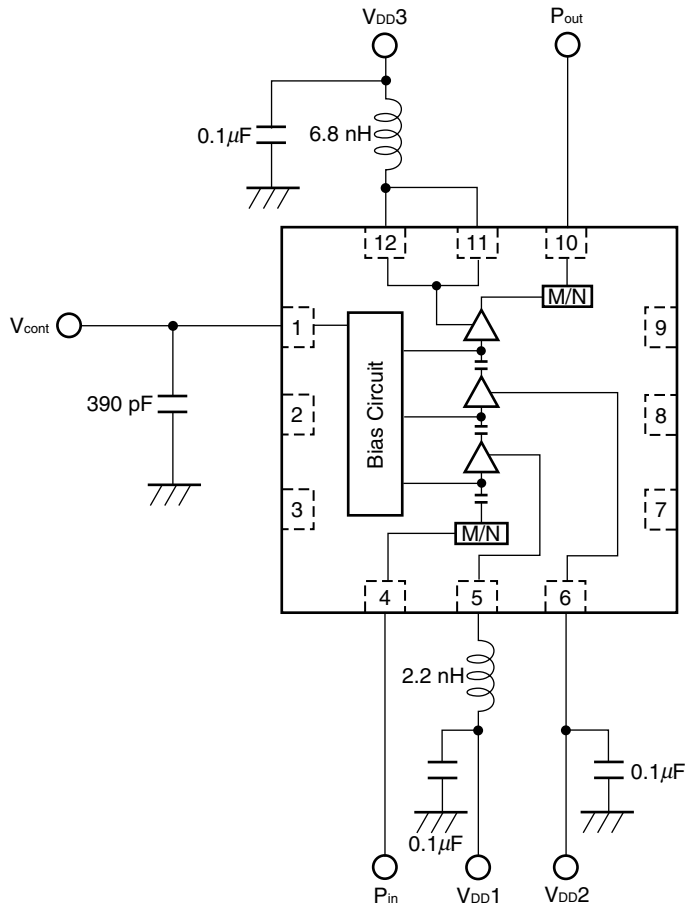
RECOMMENDED OPERATING RANGE (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f _{opt}	2 400	2 450	2 500	MHz
Supply Voltage	V _{DD1, 2, 3}	2.5	3.0	3.5	V
Control Voltage	V _{cont}	1.5	1.8	2.1	V

ELECTRICAL CHARACTERISTICS ($T_A = +25^\circ\text{C}$, $V_{DD1, 2, 3} = 3.0\text{ V}$, $V_{cont} = 1.8\text{ V}$, $f = 2.4\text{ to }2.5\text{ GHz}$, unless otherwise specified)

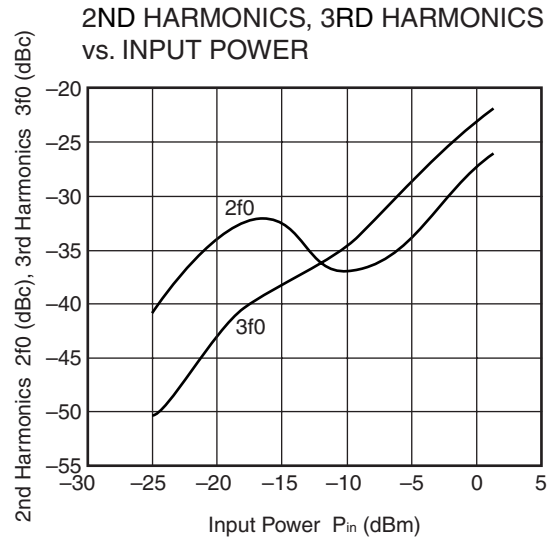
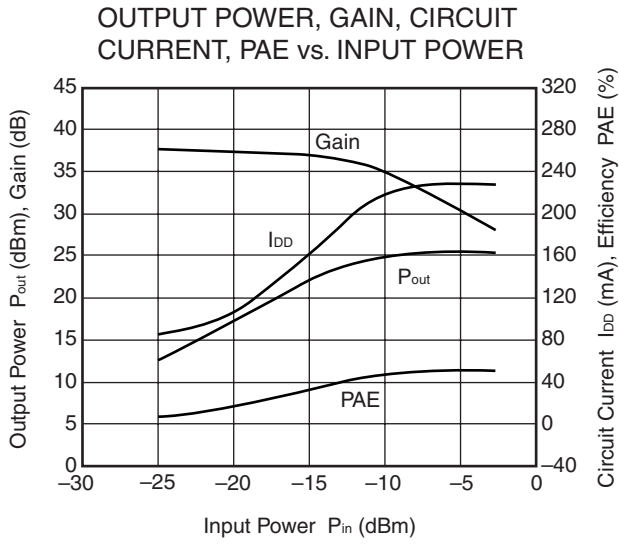
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	I_{DD}	$P_{in} = -5\text{ dBm}$	-	230	265	mA
Output Power 1	P_{out1}	$P_{in} = -5\text{ dBm}$	+23	+25	-	dBm
Output Power 2	P_{out2}	$V_{cont} = 0\text{ V}$, $P_{in} = -5\text{ dBm}$	-	-45	-30	dBm
Gain Control Range	GCR	$V_{cont} = 0\text{ to }1.8\text{ V}$, $P_{in} = -5\text{ dBm}$	-	70	-	dB
Efficiency	PAE	$P_{in} = -5\text{ dBm}$	-	47	-	%
2nd Harmonics	2f ₀	$P_{in} = -5\text{ dBm}$	-	-35	-	dBc
3rd Harmonics	3f ₀	$P_{in} = -5\text{ dBm}$	-	-30	-	dBc
Input Return Loss	RL_{in}	$P_{in} = -30\text{ dBm}$	-	-5	-	dB
Output Return Loss	RL_{out}	$P_{in} = -30\text{ dBm}$	-	-10	-	dB

EVALUATION CIRCUIT



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

TYPICAL CHARACTERISTICS ($T_A = +25^\circ\text{C}$, $V_{DD1, 2, 3} = 3.0\text{ V}$, $V_{cont} = 1.8\text{ V}$, $f = 2.45\text{ GHz}$, unless otherwise specified)

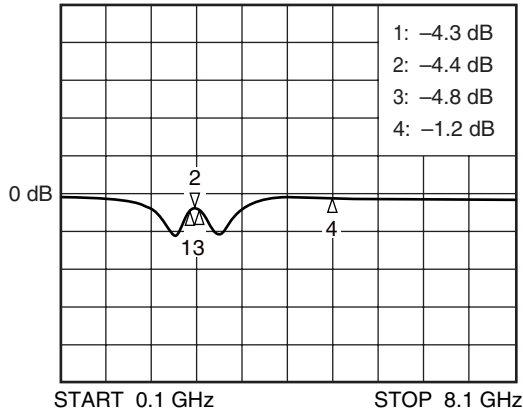


Remark The graphs indicate nominal characteristics.

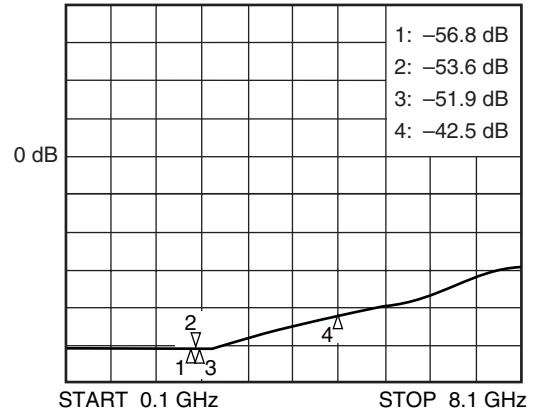
S-PARAMETERS

Condition : $T_A = +25^\circ\text{C}$, $V_{DD1, 2, 3} = 3.0\text{ V}$, $V_{cont} = 1.8\text{ V}$, $P_{in} = -30\text{ dBm}$

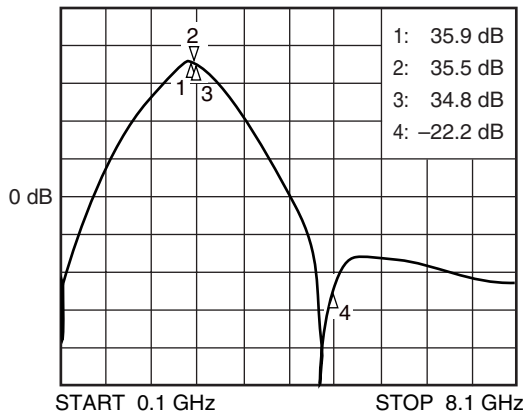
S₁₁-FREQUENCY



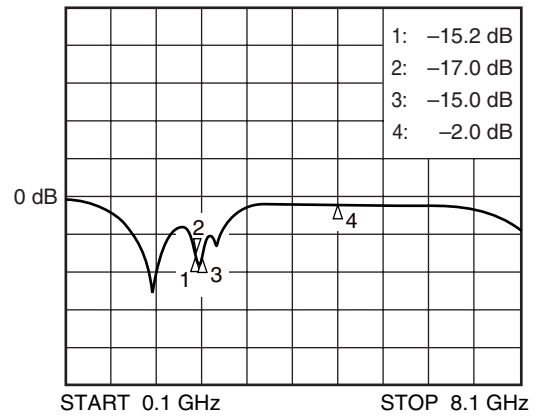
S₁₂-FREQUENCY



S₂₁-FREQUENCY



S₂₂-FREQUENCY



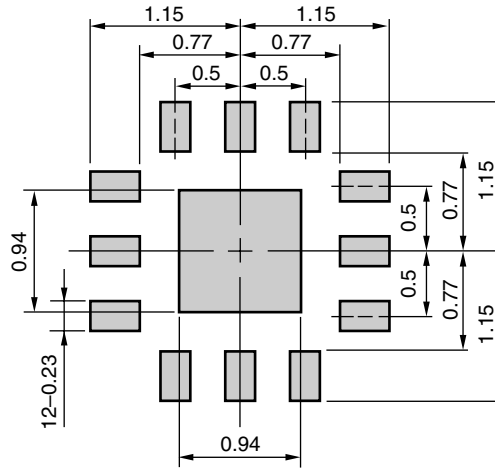
Remarks 1. The graphs indicate nominal characteristics.

2. Marker 1 : 2.4 GHz, 2 : 2.45 GHz, 3 : 2.5 GHz, 4 : 4.9 GHz

MOUNTING PAD LAYOUT DIMENSIONS

12-PIN PLASTIC TSQFN (T6M) (UNIT: mm)

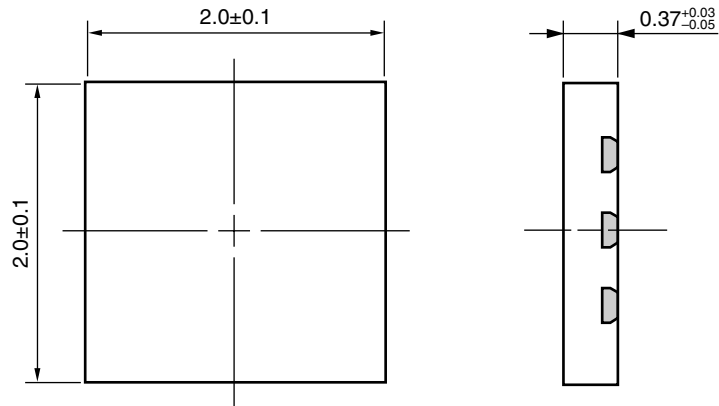
MOUNTING PAD



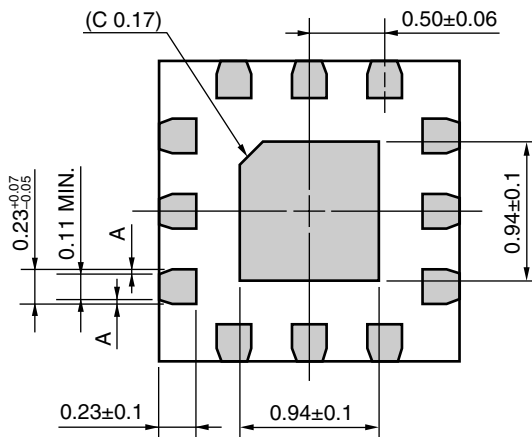
Remark The mounting pad layout in this document is for reference only.
 When designing PCB, please consider workability of mounting, solder joint reliability, prevention of solder bridge and so on, in order to optimize the design.

PACKAGE DIMENSIONS

12-PIN PLASTIC TSQFN (T6M) (UNIT: mm)



(Bottom View)



Remark A > 0

(): Reference value

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below
	Time at peak temperature	: 10 seconds or less
	Time at temperature of 220°C or higher	: 60 seconds or less
	Preheating time at 120 to 180°C	: 120±30 seconds
	Maximum number of reflow processes	: 3 times
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below
Partial Heating	Peak temperature (terminal temperature)	: 350°C or below
	Soldering time (per side of device)	: 3 seconds or less
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below

Caution Do not use different soldering methods together (except for partial heating).

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M8E0904E

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